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Special Issue: LabVIEW Applications in Engineering Education
Guest Editors: Nesimi Ertugrul and Jim Henry

Contents

M. S. Wald
Editorial

Nesimi Ertugrul
Guest Editorial

Nesimi Ertugrul
Towards Virtual Laboratories: a Survey of LabVIEW-based Teaching/
Learning Tools and Future Trends

Ben Erwin, Martha Cyr and Chris Rogers
LEGO Engineer and RoboLab: Teaching Engineering with LabVIEW from
Kindergarten to Graduate School

Ryan B. Wicker and Hugo I. Loya
A Vision-based Experiment for Mechanical Engineering Laboratory
Courses

J. P. Keller
Teaching PID and Fuzzy Controllers with LabVIEW

A. Bruce Buckman
VI-Based Introductory Electrical Engineering Laboratory Course

Trudy L. Schwartz and Bradley M. Dunkin
Facilitating Interdisciplinary Hands-on Learning using LabVIEW

A. Bruce Buckman
A Course in Computer-based Instrumentation: learning LabVIEW™ with
Case Studies

Warren D. Smith, Gregory B. Williams,
Ramon Berguer and John T. Anderson
LabVIEW™ Facilitates Interdisciplinary Team Projects in Graduate
Biomedical Engineering Courses

J. B. Olansen, F. Ghorbel, J. W. Clark, Jr. and
A. Bidani
Using Virtual Instrumentation to Develop a Modern Biomedical
Engineering Laboratory

Ch. Salzmann, D. Gillet and P. Huguenin
Introduction to Real-time Control using LabVIEW™ with an Application
to Distance Learning

K. K. Tan, T. H. Lee and F. M. Leu
Development of a Distant Laboratory using LabVIEW

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